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BIBDATASHEET**CONFIRMATION NO. 7641**

Bib Data Sheet

SERIAL NUMBER 10/065,568	FILING DATE 10/31/2002 RULE	CLASS 438	GROUP ART UNIT 2824	ATTORNEY DOCKET NO. NAUP0482USA
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APPLICANTS

Kuo-Ming Chen, Hsin-Chu Hsien, TAIWAN;

Hung-Min Liu, Hsin-Chu City, TAIWAN;

** CONTINUING DATA *****

None
MSC

** FOREIGN APPLICATIONS *****

None
MSC

IF REQUIRED, FOREIGN FILING LICENSE GRANTED

** 11/07/2002

Foreign Priority claimed <input type="checkbox"/> yes <input checked="" type="checkbox"/> no	STATE OR COUNTRY TAIWAN	SHEETS DRAWING 8	TOTAL CLAIMS 10	INDEPENDENT CLAIMS 2
35 USC 119 (a-d) conditions met <input type="checkbox"/> yes <input checked="" type="checkbox"/> no <input type="checkbox"/> Met after Alliance				
Verified and Acknowledged	Examiner's Signature <i>MSC</i>	Initials		

ADDRESS

027765

NAIPO (NORTH AMERICA INTERNATIONAL PATENT OFFICE)

P.O. BOX 506

MERRIFIELD , VA

22116

TITLE

Solder bump structure and laser repair process for memory device

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